VSSAF3N50

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Vishay General Semiconductor

Surface-Mount TMBS[®] (Trench MOS Barrier Schottky) Rectifier



LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS				
I _{F(AV)}	3.0 A			
V _{RRM}	50 V			
I _{FSM}	80 A			
V_F at I_F = 3.0 A	0.40 V			
T _J max.	150 °C			
Package	SlimSMA (DO-221AC)			
Circuit configuration	Single			

FEATURES

- Very low profile typical height of 0.95 mm
- Ideal for automated placement
- Trench MOS Schottky technology
- · Low power losses, high efficiency
- Low forward voltage drop
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

For use in low voltage, high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.

MECHANICAL DATA

Case: SlimSMA (DO-221AC)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD22-B102

M3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes cathode end

MAXIMUM RATINGS (T_A = 25 °C unless otherwise noted)PARAMETERSYMBOL

PARAMETER	SYMBOL	VSSAF3N50	UNIT	
Device marking code		3N5		
Maximum repetitive peak reverse voltage	V _{RRM}	RRM 50		
Maximum DC forward current (fig. 1)	I _F ⁽¹⁾	3.0	A	
Maximum DC forward current (fig. 1)	I _F ⁽²⁾	2.7		
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I _{FSM}	80	А	
Maximum DC reserve voltage	V _{DC}	35	V	
Operating junction and storage temperature range	T _J , T _{STG}	-40 to +150	°C	

Note

⁽¹⁾ Mounted on 5 mm x 5 mm copper pad areas, 2 oz. FR4 PCB

⁽²⁾ Free air, mounted on recommended copper pad area

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ELECTRICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise noted)						
PARAMETER	TEST CO	TEST CONDITIONS		TYP.	MAX.	UNIT
Instantaneous forward voltage	I _F = 1.5 A	T _A = 25 °C	– V _F ⁽¹⁾	0.40	-	V
	I _F = 3.0 A			0.47	0.54	
	I _F = 1.5 A	- T _A = 125 °C		0.30	-	
	I _F = 3.0 A			0.40	0.48	
Reverse current	V _B = 35 V	/ T _A = 25 °C	I _R (2)	0.01	-	- mA
	$v_{\rm R} = 35 v$	T _A = 125 °C		8	-	
	V _B = 50 V	$T_{A} = 25 \text{ °C}$		-	1	
	$v_{\rm R} = 50 v$	T _A = 125 °C		12.5	35	
Typical junction capacitance	4.0 V, 1 MF	4.0 V, 1 MHz		570	-	pF

Notes

 $^{(1)}\,$ Pulse test: 300 μs pulse width, 1 % duty cycle

⁽²⁾ Pulse test: Pulse width \leq 5 ms

THERMAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise specified)				
PARAMETER	SYMBOL	VSSAF3N50	UNIT	
Typical thermal resistance	R _{0JA} ⁽¹⁾	115	°C/W	
	R _{0JM} ⁽¹⁾	12	0/10	

Note

⁽¹⁾ Free air, mounted on recommended PCB, 2 oz. pad area; thermal resistance $R_{\theta,JA}$ - junction to ambient, $R_{\theta,JM}$ - junction to mount

ORDERING INFORMATION (Example)						
PREFERRED P/N	UNIT WEIGHT (g)	IIT WEIGHT (g) PREFERRED PACKAGE CODE		DELIVERY MODE		
VSSAF3N50-M3/6A	0.032	6A	3500	7" diameter plastic tape and reel		
VSSAF3N50-M3/6B	0.032	6B	14 000	13" diameter plastic tape and reel		



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RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

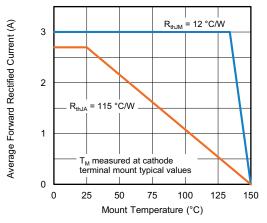


Fig. 1 - Maximum Forward Current Derating Curve

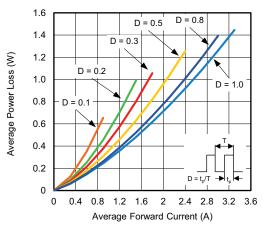


Fig. 2 - Forward Power Loss Characteristics

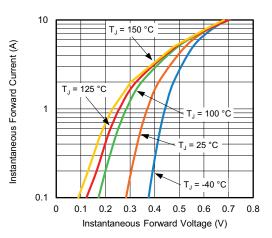


Fig. 3 - Typical Instantaneous Forward Characteristics

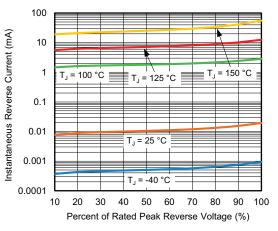


Fig. 4 - Typical Reverse Leakage Characteristics

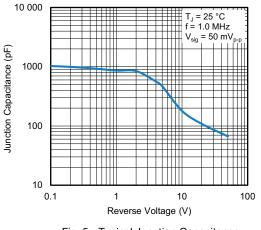


Fig. 5 - Typical Junction Capacitance

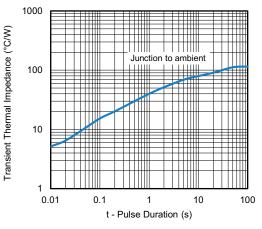


Fig. 6 - Typical Transient Thermal Impedance

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3

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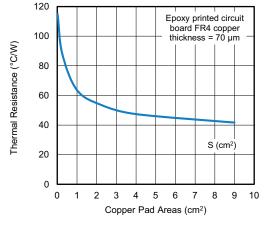
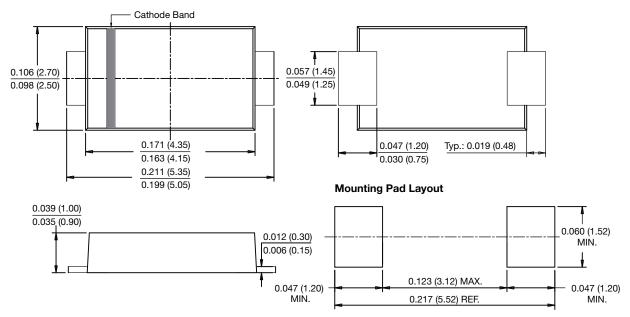


Fig. 7 - Thermal Resistance Junction to Ambient vs. Copper Pad Area

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)



SlimSMA (DO-221AC)



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